Noise Suppression Products/EMI Suppression Filters > EMIFIL® (LC Combined) > Array

1

Data Sheet

EMIFIL[®] (LC Combined) Array NFA21SL_X Series (0805 Size)

Equivalent Circuit

Packaging
Code

L

в

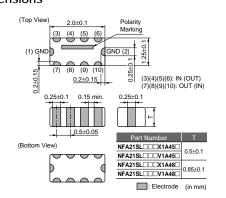
(1) GNI

Packaging

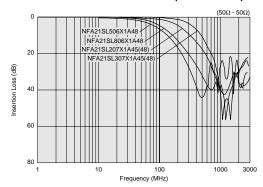
180mm Embossed Tape

Bulk(Bag)

Dimensions



■ Insertion Loss Characteristics (Main Items)



■ Rated Value (□: packaging code)

Part Number	Nominal Cut-off Frequency	Insertion Loss (Cut-off Frequency)	Insertion Loss (500MHz) (min.)	Insertion Loss (800MHz) (min.)	Insertion Loss (1000MHz) (min.)	Rated Voltage	Rated Current	Insulation Resistance (min.)	Withstand Voltage
NFA21SL207X1A45	200MHz	2 to 7	13dB	25dB	25dB	10Vdc	100mA	1000M ohm	30Vdc
NFA21SL307X1A45	300MHz	2 to 7	7dB	20dB	25dB	10Vdc	100mA	1000M ohm	30Vdc
NFA21SL506X1A48	50MHz	0 to 6	30dB	-	20dB	10Vdc	20mA	1000M ohm	30Vdc
NFA21SL806X1A48	80MHz	2 to 7	25dB	-	25dB	10Vdc	20mA	1000M ohm	30Vdc
NFA21SL207X1A48	200MHz	2 to 7	13dB	25dB	25dB	10Vdc	100mA	1000M ohm	30Vdc
NFA21SL307X1A48	300MHz	2 to 7	7dB	20dB	25dB	10Vdc	100mA	1000M ohm	30Vdc

Operating Temperature Range: -55°C to +125°C Number of Circuits: 4

Continued on the following page.

GND (2)

Minimum Quantity

4000

1000

• This data sheet is applied for LC Combined CHIP EMIFIL[®] used for General Electronics equipment for your design.

A Note:

1. This datasheet is downloaded from the website of Murata Manufacturing co., ltd. Therefore, it's specifications are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering.

2. This datasheet has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product

specifications or transact the approval sheet for product specifications before ordering.



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Data Sheet

Continued from the preceding page.

■ ①Caution/Notice

Caution (Rating)

Do not use products beyond the rated current and rated voltage as this may create excessive heat and deteriorate the insulation resistance. Notice

Solderability of Tin plating termination chip might be deteriorated when low temperature soldering profile where peak solder temperature is below the Tin melting point is used. Please confirm the solderability of Tin plating termination chip before use.

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